

TDK item description CGA5L2X8R1H334KT****

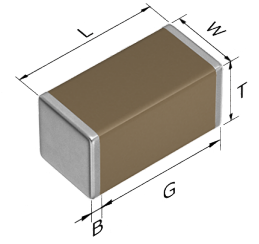
Applications Automotive Grade

Feature AEC-Q200

High Temperature Application

Series CGA5(3216) [EIA 1206]

Status Production



Size

Length(L)	3.20mm ±0.20mm
Width(W)	1.60mm ±0.20mm
Thickness(T)	1.60mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern (PA)	2.10mm to 2.50mm(Flow Soldering)
	2.00mm to 2.40mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.10mm to 1.30mm(Flow Soldering)
	1.00mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PC)	1.00mm to 1.30mm(Flow Soldering)
	1.10mm to 1.60mm(Reflow Soldering)

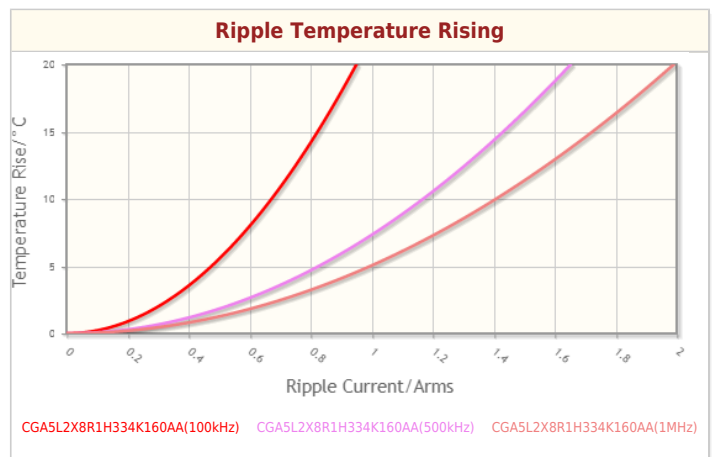
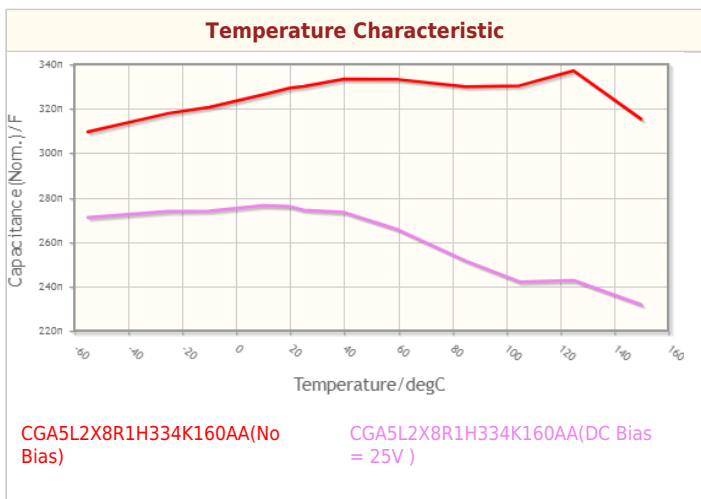
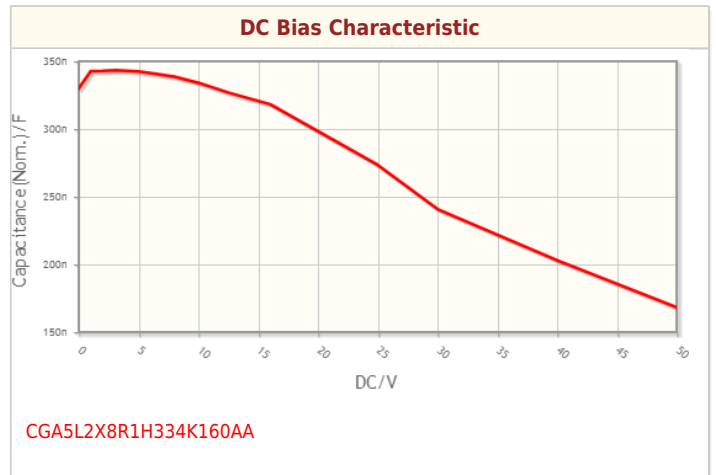
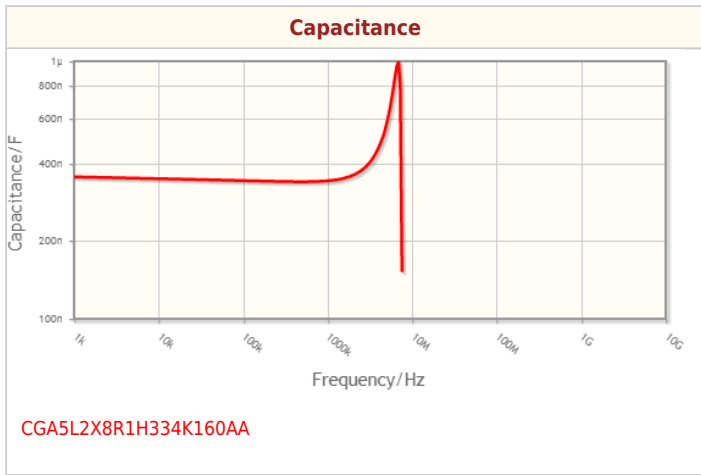
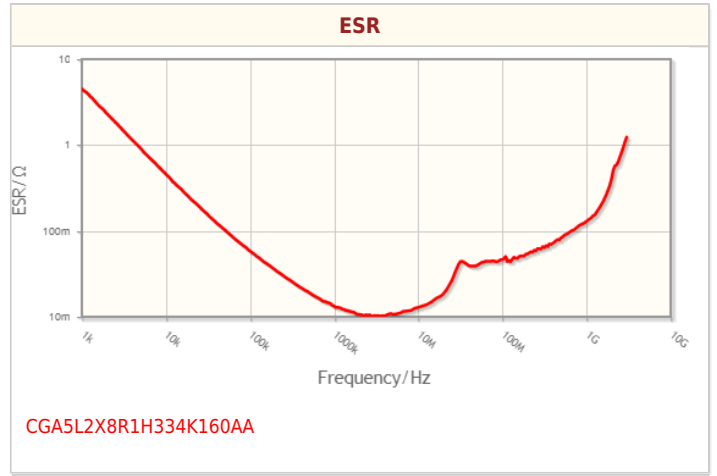
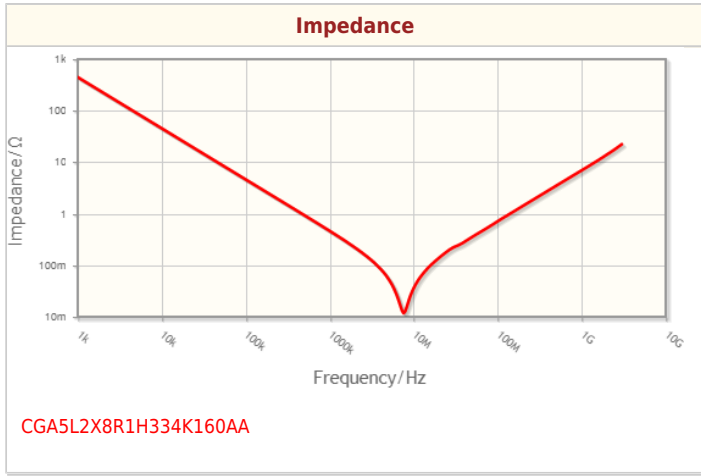
Electrical Characteristics

Capacitance	330nF ±10%
Rated Voltage	50VDC
Temperature Characteristic	X8R(±15%)
Dissipation Factor (Max.)	3%
Insulation Resistance (Min.)	1515MΩ

Other

Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

Associated Images

